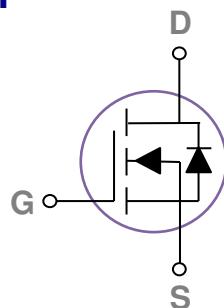


### General Description

These N-Channel enhancement mode power field effect transistors are using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.

### TO263 Pin Configuration



BVDSS	RDS(ON)	ID
100V	2.3mΩ	250A

### Features

- 100V,250A, RDS(ON) =2.3mΩ@VGS = 10V
- Improved dv/dt capability
- Fast switching
- 100% EAS Guaranteed
- Green Device Available

### Applications

- Networking
- Load Switch
- LED applications
- Quick Charger

### Absolute Maximum Ratings $T_c=25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Rating	Units
$V_{DS}$	Drain-Source Voltage	100	V
$V_{GS}$	Gate-Source Voltage	+20/-12	V
$I_D$	Drain Current – Continuous ( $T_c=25^\circ\text{C}$ )	250	A
	Drain Current – Continuous ( $T_c=100^\circ\text{C}$ )	158	A
$I_{DM}$	Drain Current – Pulsed <sup>1</sup>	1000	A
EAS	Single Pulse Avalanche Energy <sup>2</sup>	938	mJ
IAS	Single Pulse Avalanche Current <sup>2</sup>	137	A
$P_D$	Power Dissipation ( $T_c=25^\circ\text{C}$ )	416	W
	Power Dissipation – Derate above 25°C	3.3	W/°C
$T_{STG}$	Storage Temperature Range	-50 to 150	°C
$T_J$	Operating Junction Temperature Range	-50 to 150	°C

### Thermal Characteristics

Symbol	Parameter	Typ.	Max.	Unit
$R_{\theta JA}$	Thermal Resistance Junction to ambient	---	62	°C/W
$R_{\theta JC}$	Thermal Resistance Junction to Case	---	0.3	°C/W



100V N-Channel MOSFETs

PDH0080A

**Electrical Characteristics (T<sub>J</sub>=25 °C, unless otherwise noted)****Off Characteristics**

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V , I <sub>D</sub> =250uA	100	---	---	V
I <sub>DSS</sub>	Drain-Source Leakage Current	V <sub>DS</sub> =100V , V <sub>GS</sub> =0V , T <sub>J</sub> =25°C	---	---	1	uA
		V <sub>DS</sub> =80V , V <sub>GS</sub> =0V , T <sub>J</sub> =85°C	---	---	10	uA
I <sub>GSS</sub>	Gate-Source Leakage Current	V <sub>GS</sub> =20V , V <sub>DS</sub> =0V	---	---	100	nA

**On Characteristics**

R <sub>DSON</sub>	Static Drain-Source On-Resistance	V <sub>GS</sub> =10V , I <sub>D</sub> =40A	---	1.9	2.3	mΩ
V <sub>GS(th)</sub>	Gate Threshold Voltage	V <sub>GS</sub> =V <sub>DS</sub> , I <sub>D</sub> =250uA	2	2.5	4	V
g <sub>fS</sub>	Forward Transconductance	V <sub>DS</sub> =10V , I <sub>D</sub> =3A	---	20	---	S

**Dynamic and switching Characteristics**

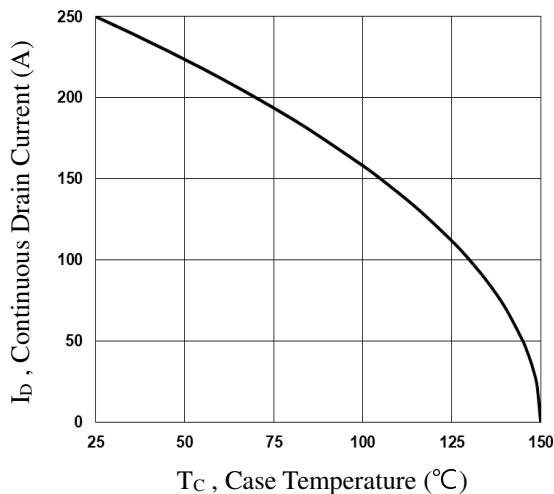
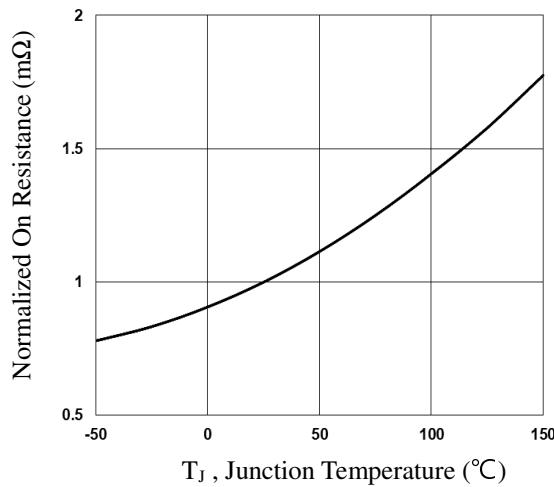
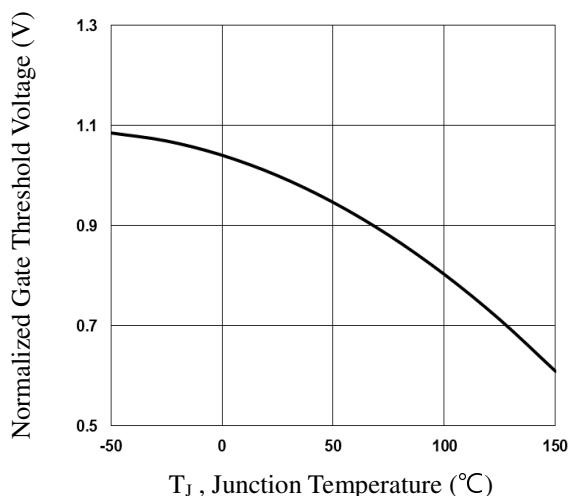
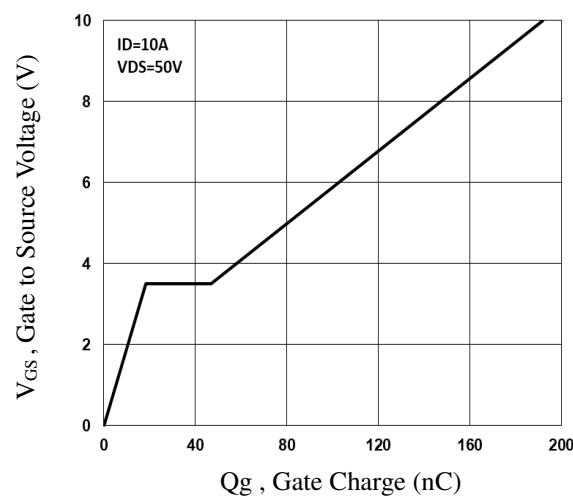
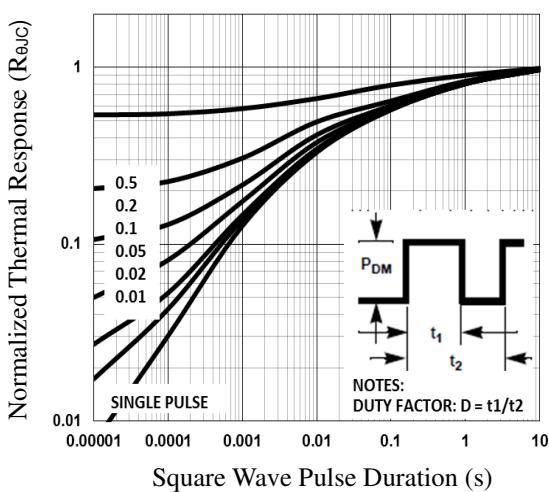
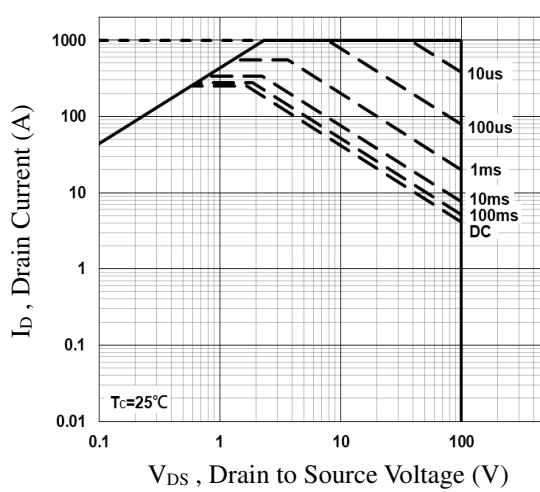
Q <sub>g</sub>	Total Gate Charge <sup>3, 4</sup>	V <sub>DS</sub> =50V , V <sub>GS</sub> =10V , I <sub>D</sub> =10A	---	192	175	nC
Q <sub>gs</sub>	Gate-Source Charge <sup>3, 4</sup>		---	18.5	37	
Q <sub>gd</sub>	Gate-Drain Charge <sup>3, 4</sup>		---	28.3	56	
T <sub>d(on)</sub>	Turn-On Delay Time <sup>3, 4</sup>	V <sub>DD</sub> =50V , V <sub>GS</sub> =10V , R <sub>G</sub> =3.3Ω I <sub>D</sub> =1A	---	20.6	42	ns
T <sub>r</sub>	Rise Time <sup>3, 4</sup>		---	19.8	40	
T <sub>d(off)</sub>	Turn-Off Delay Time <sup>3, 4</sup>		---	66	132	
T <sub>f</sub>	Fall Time <sup>3, 4</sup>		---	117	234	
C <sub>iss</sub>	Input Capacitance	V <sub>DS</sub> =50V , V <sub>GS</sub> =0V , F=1MHz	---	10100	15200	pF
C <sub>oss</sub>	Output Capacitance		---	2020	3100	
C <sub>rss</sub>	Reverse Transfer Capacitance		---	53	80	
R <sub>g</sub>	Gate resistance	V <sub>GS</sub> =0V, V <sub>DS</sub> =0V, F=1MHz	---	1.1	---	Ω

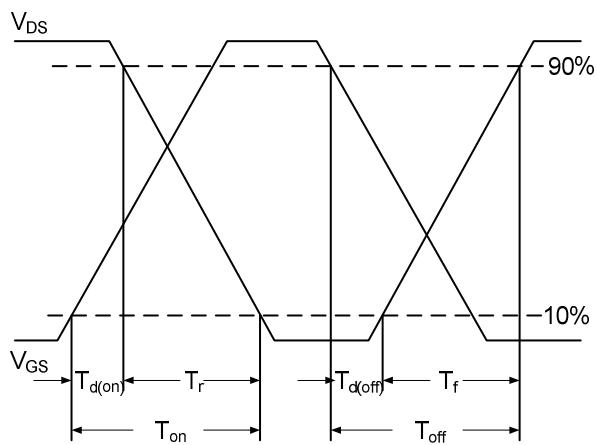
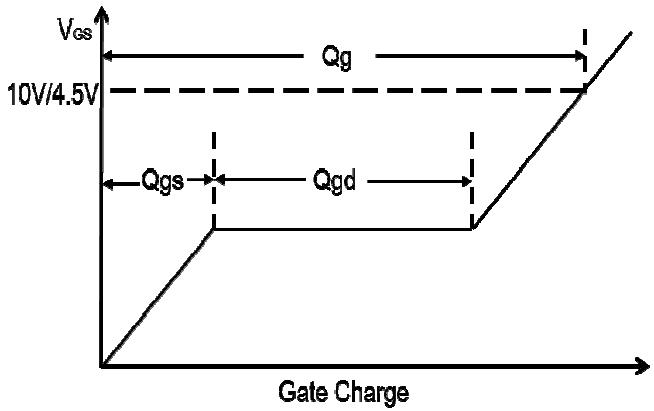
**Drain-Source Diode Characteristics and Maximum Ratings**

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
I <sub>s</sub>	Continuous Source Current	V <sub>G</sub> =V <sub>D</sub> =0V , Force Current	---	---	250	A
I <sub>SM</sub>	Pulsed Source Current		---	---	500	A
V <sub>SD</sub>	Diode Forward Voltage	V <sub>GS</sub> =0V , I <sub>s</sub> =1A , T <sub>J</sub> =25°C	---	---	1	V
t <sub>rr</sub>	Reverse Recovery Time	V <sub>R</sub> =100V, I <sub>s</sub> =10A di/dt=100A/μs, T <sub>J</sub> =25°C	---	95	---	ns
Q <sub>rr</sub>	Reverse Recovery Charge		---	610	---	nC

Note :

1. Repetitive Rating : Pulsed width limited by maximum junction temperature.
2. V<sub>DD</sub>=50V, V<sub>GS</sub>=10V,L=0.1mH,I<sub>AS</sub>=137A.,R<sub>G</sub>=25Ω,Starting T<sub>J</sub>=25°C.
3. The data tested by pulsed , pulse width ≤ 300us , duty cycle ≤ 2%.
4. Essentially independent of operating temperature.


**Fig.1 Continuous Drain Current vs. T<sub>c</sub>**

**Fig.2 Normalized RDSON vs. T<sub>j</sub>**

**Fig.3 Normalized V<sub>th</sub> vs. T<sub>j</sub>**

**Fig.4 Gate Charge Characteristics**

**Fig.5 Normalized Transient Impedance**

**Fig.6 Maximum Safe Operation Area**


**Fig.7 Switching Time Waveform**

**Fig.8 Gate Charge Waveform**

## TO263 PACKAGE INFORMATION

